

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Udo Hartmann</td><td>12/19/2005</td></tr><tr><td>Jochen Kallscheuer</td><td>12/20/2005</td></tr><tr><td>Patric Stracke</td><td>12/14/2005</td></tr></tbody></table>	Name	Execution Date	Udo Hartmann	12/19/2005	Jochen Kallscheuer	12/20/2005	Patric Stracke	12/14/2005	
Name	Execution Date								
Udo Hartmann	12/19/2005								
Jochen Kallscheuer	12/20/2005								
Patric Stracke	12/14/2005								
RECEIVING PARTY DATA									
Name:	Infineon Technologies AG								
Street Address:	St.-Martin-Str. 53								
City:	Munich								
State/Country:	GERMANY								
Postal Code:	81669								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11288416</td></tr></tbody></table>	Property Type	Number	Application Number:	11288416					
Property Type	Number								
Application Number:	11288416								
CORRESPONDENCE DATA									
Fax Number: (301)762-4056 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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Email: jkw@usiplaw.com									
Correspondent Name: PJF (Edell, Shapiro & Finnan)									
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Address Line 2: Suite 400									
Address Line 4: Rockville, MARYLAND 20850									
NAME OF SUBMITTER:	Patrick J. Finnan								
Total Attachments: 3 source=Executed Assignment#page1.tif source=Executed Assignment#page2.tif source=Executed Assignment#page3.tif									

OP \$40.00 11288416

PATENT

500078606

REEL: 017173 FRAME: 0774

## ASSIGNMENT

For good and valuable consideration, WE, **Udo Hartmann**, a citizen of Germany, residing at Ettaler Straße 31, 82061 Neuried, Germany; **Jochen Kallscheuer**, a citizen of Germany, residing at Sebastian-Bauer-Straße 33, 81737 München, Germany; and **Patric Stracke**, a citizen of Germany, residing at Hessstraße 37, 80798 München, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:


### METHOD FOR TESTING SEMICONDUCTOR CHIPS USING REGISTER SETS

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

**Udo Hartmann**  
SIGNATURE:



DATE: Dec. 19. 2005

**Jochen Kallscheuer**  
SIGNATURE:

DATE:

**Patric Stracke**  
SIGNATURE:

DATE:

## ASSIGNMENT

For good and valuable consideration, WE, **Udo Hartmann**, a citizen of Germany, residing at Ettaler Straße 31, 82061 Neuried, Germany; **Jochen Kallscheuer**, a citizen of Germany, residing at Sebastian-Bauer-Straße 33, 81737 München, Germany; and **Patric Stracke**, a citizen of Germany, residing at Hessesstraße 37, 80798 München, Germany, hereinafter individually or collectively referred to as "Assignor";

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Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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**Udo Hartmann**  
SIGNATURE:

DATE:

**Jochen Kallscheuer**  
SIGNATURE:



DATE: 20.12.2005

**Patric Stracke**  
SIGNATURE:

DATE:

## ASSIGNMENT

For good and valuable consideration, WE, **Udo Hartmann**, a citizen of Germany, residing at Ettaler Straße 31, 82061 Neuried, Germany; **Jochen Kallscheuer**, a citizen of Germany, residing at Sebastian-Bauer-Straße 33, 81737 München, Germany; and **Patric Stracke**, a citizen of Germany, residing at Hessesstraße 37, 80798 München, Germany, hereinafter individually or collectively referred to as "Assignor";

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**Udo Hartmann**  
SIGNATURE:

DATE:

**Jochen Kallscheuer**  
SIGNATURE:

DATE:

**Patric Stracke**  
SIGNATURE:



DATE: 14.12.2005